

ESD5V3U4RRS

Ultra-Low Capacitance ESD Diode Array

- Rail-to-rail diodes with internal TVS diode
- ESD / transient protection of four I/O lines and one Vcc line exceeding: IEC61000-4-2 (ESD): ± 15 kV (contact) IEC61000-4-4 (EFT): 2.5 kV / 50 A (5/50 ns) IEC61000-4-5 (surge): 3 A (8/20 μs)
- Reverse working voltage data lines: 5.3 V max.
- Reverse working voltage Vcc: 6 V max.
- Very low capacitance: 0.4 pF typ.
- Very low reverse current < 10 nA typ.
- Very low clamping voltage:
 12 V typ. at positive transients
 4 V typ. at negative transients
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101

Applications

- USB 2.0 ports and future USB 3.0 ports
- Ethernet port: 10/100/1000 Mb/s
- IEEE 1394 FireWire ports
- Mobile communications e.g. high-speed SIM card protection
- Consumer products (STB, DVD, DSC, DVC...)
- Notebooks and desktop computers, peripherals



ESD5V3U4RRS



Туре	Package	Configuration	Marking
ESD5V3U4RRS	SOT363	6 pins, uni-directional	E8s





Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit			
ESD contact discharge ¹⁾	V _{ESD}	15	kV			
Peak pulse current ($t_p = 8 / 20 \ \mu s$) ²⁾	I _{pp}	3	A			
Peak pulse power ($t_p = 8 / 20 \ \mu s$) ²⁾	P _{pk}	50	W			
Operating temperature range	T _{op}	-55125	°C			
Storage temperature	T _{stq}	-65150				

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values		Unit	
		min.	typ.	max.	
Characteristics ³⁾					
Reverse working voltage	V _{RWM}				V
I/O pin ⁴⁾ to pin 5		-	-	5.3	
pin 2 to pin 5		-	-	6	
Breakdown voltage	V _(BR)	6.3	-	-	
$I_{(BR)}$ = 1 mA, any pin to pin 5					
Reverse current	I _R	-	< 10	100	nA
$V_{\rm R}$ = 5.3 V, any pin to pin 5					
Clamping voltage	V _{CL}				V
$I_{\rm PP}$ = 1 A, $t_{\rm p}$ = 8/20 µs ²⁾ , any pin to pin 5		-	10	13	
I_{PP} = 3 A, t_{p} = 8/20 µs ²⁾ , any pin to pin 5		-	12	15	
Forward clamping voltage	V _{FC}				
$I_{\rm PP}$ = 1 A, $t_{\rm p}$ = 8/20 µs ²⁾ , any pin to pin 5		-	2	4	
$I_{\rm PP}$ = 3 A, $t_{\rm p}$ = 8/20 µs ²⁾ , any pin to pin 5		-	4	6	
Line capacitance ⁵⁾⁴⁾	CT	-	0.4	0.6	pF
$V_{\rm R}$ = 0 V, f = 1 MHz, any I/O pin to pin 5					

 $^{1}V_{\text{ESD}}$ according to IEC61000-4-2

 $^{2}I_{pp}$ according to IEC61000-4-5

³It is strongly recommended that pin 5 is connected to ground for propper functionality.

⁴I/0 pins are pin 1, 3, 4, 6

⁵Total capacitance line to ground



Power derating curve $P_{pk} = f(T_A)$



Forward clamping voltage $V_{FC} = f(I_{PP})$ $t_p = 8 / 20 \ \mu s$



Clamping voltage, $V_{cl} = f(I_{pp})$ $t_p = 8 / 20 \ \mu s$



Reverse current $I_{R} = f(V_{R})$ T_{A} = Parameter





Diode capacitance $C_{T} = f(V_{R})$

f = 1MHz





Application example ESD5V3U4RRS

4 data lines, uni-directional



Application example ESD5V3U4RRS

4 data lines and 1 power supply line, uni-directional







Foot Print



Marking Layout (Example)

Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.





Edition 2006-02-01 Published by Infineon Technologies AG 81726 München, Germany © Infineon Technologies AG 2007. All Rights Reserved.

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